## Kyung Jean Yoon

List of Publications by Year in descending order

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#	Article	IF	CITATIONS
1	A Review of Threeâ€Dimensional Resistive Switching Crossâ€Bar Array Memories from the Integration and Materials Property Points of View. Advanced Functional Materials, 2014, 24, 5316-5339.	14.9	319
2	Highly Uniform, Electroformingâ€Free, and Selfâ€Rectifying Resistive Memory in the Pt/Ta <sub>2</sub> O <sub>5</sub> /HfO <sub>2â€x</sub> /TiN Structure. Advanced Functional Materials, 2014, 24, 5086-5095.	14.9	197
3	Highly Improved Uniformity in the Resistive Switching Parameters of TiO <sub>2</sub> Thin Films by Inserting Ru Nanodots. Advanced Materials, 2013, 25, 1987-1992.	21.0	170
4	32 × 32 Crossbar Array Resistive Memory Composed of a Stacked Schottky Diode and Unipolar Resistive Memory. Advanced Functional Materials, 2013, 23, 1440-1449.	14.9	152
5	Pt/Ta <sub>2</sub> O <sub>5</sub> /HfO <sub>2â^'</sub> <i><sub>x</sub></i> /Ti Resistive Switching Memory Competing with Multilevel NAND Flash. Advanced Materials, 2015, 27, 3811-3816.	21.0	152
6	Nociceptive Memristor. Advanced Materials, 2018, 30, 1704320.	21.0	116
7	Electronic resistance switching in the Al/TiO <sub>x</sub> /Al structure for forming-free and area-scalable memory. Nanoscale, 2015, 7, 11063-11074.	5.6	78
8	Memristive tri-stable resistive switching at ruptured conducting filaments of a Pt/TiO <sub>2</sub> /Pt cell. Nanotechnology, 2012, 23, 185202.	2.6	69
9	Titanium dioxide thin films for next-generation memory devices. Journal of Materials Research, 2013, 28, 313-325.	2.6	67
10	Improved endurance of resistive switching TiO2 thin film by hourglass shaped Magnéli filaments. Applied Physics Letters, 2011, 98, .	3.3	65
11	What Will Come After Vâ€NAND—Vertical Resistive Switching Memory?. Advanced Electronic Materials, 2019, 5, 1800914.	5.1	61
12	Fabrication of a Cu oneâ€Shaped Cation Source Inserted Conductive Bridge Random Access Memory and Its Improved Switching Reliability. Advanced Functional Materials, 2019, 29, 1806278.	14.9	51
13	Double‣ayerâ€Stacked One Diodeâ€One Resistive Switching Memory Crossbar Array with an Extremely High Rectification Ratio of 10 <sup>9</sup> . Advanced Electronic Materials, 2017, 3, 1700152.	5.1	42
14	Substrate Dependent Growth Behaviors of Plasma-Enhanced Atomic Layer Deposited Nickel Oxide Films for Resistive Switching Application. Chemistry of Materials, 2012, 24, 4675-4685.	6.7	36
15	A Stateful Logic Family Based on a New Logic Primitive Circuit Composed of Two Antiparallel Bipolar Memristors. Advanced Intelligent Systems, 2020, 2, 1900082.	6.1	36
16	Evolution of the shape of the conducting channel in complementary resistive switching transition metal oxides. Nanoscale, 2014, 6, 2161-2169.	5.6	35
17	Comprehensive Writing Margin Analysis and its Application to Stacked one Diodeâ€One Memory Device for Highâ€Density Crossbar Resistance Switching Random Access Memory. Advanced Electronic Materials, 2016, 2, 1600326.	5.1	34
18	Uniform Self-rectifying Resistive Switching Behavior via Preformed Conducting Paths in a Vertical-type Ta <sub>2</sub> O <sub>5</sub> /HfO <sub>2–<i>x</i>Sub&gt; Structure with a Sub-î¼m<sup>2</sup> Cell Area. ACS Applied Materials &amp; Interfaces, 2016, 8, 18215-18221.</sub>	8.0	34

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19	Fully Functional Logicâ€Inâ€Memory Operations Based on a Reconfigurable Finiteâ€State Machine Using a Single Memristor. Advanced Electronic Materials, 2018, 4, 1800189.	5.1	33
20	Schottky diode with excellent performance for large integration density of crossbar resistive memory. Applied Physics Letters, 2012, 100, .	3.3	32
21	Inâ€Memory Stateful Logic Computing Using Memristors: Gate, Calculation, and Application. Physica Status Solidi - Rapid Research Letters, 2021, 15, 2100208.	2.4	25
22	A crossbar resistance switching memory readout scheme with sneak current cancellation based on a two-port current-mode sensing. Nanotechnology, 2016, 27, 485201.	2.6	24
23	Filament Shape Dependent Reset Behavior Governed by the Interplay between the Electric Field and Thermal Effects in the Pt/TiO <sub>2</sub> /Cu Electrochemical Metallization Device. Advanced Electronic Materials, 2017, 3, 1600404.	5.1	24
24	Comparison of the Atomic Layer Deposition of Tantalum Oxide Thin Films Using Ta(N <sup><i>t</i></sup> Bu)(NEt <sub>2</sub> ) <sub>3</sub> , Ta(N <sup><i>t</i></sup> Bu)(NEt <sub>2</sub> ) <sub>2</sub> Cp, and H <sub>2</sub> O. ACS Applied Materials & amp; Interfaces, 2017, 9, 537-547.	8.0	23
25	Single ell Stateful Logic Using a Dualâ€Bit Memristor. Physica Status Solidi - Rapid Research Letters, 2019, 13, 1800629.	2.4	23
26	A study of the transition between the non-polar and bipolar resistance switching mechanisms in the TiN/TiO <sub>2</sub> /Al memory. Nanoscale, 2016, 8, 16455-16466.	5.6	22
27	Ionic bipolar resistive switching modes determined by the preceding unipolar resistive switching reset behavior in Pt/TiO2/Pt. Nanotechnology, 2013, 24, 145201.	2.6	19
28	Resistance switching behavior of atomic layer deposited SrTiO3 film through possible formation of Sr2Ti6O13 or Sr1Ti11O20 phases. Scientific Reports, 2016, 6, 20550.	3.3	17
29	Interface engineering for improving reliability of resistance switching in Cu/HfO2/TiO2/Pt structure. Applied Physics Letters, 2015, 107, .	3.3	16
30	Optimization of Chemical Structure of Schottky-Type Selection Diode for Crossbar Resistive Memory. ACS Applied Materials & Interfaces, 2012, 4, 5338-5345.	8.0	9
31	Control of conducting filaments in TiO2 films by a thin interfacial conducting oxide layer at the cathode. Applied Physics Letters, 2013, 102, 082903.	3.3	7
32	Resistive Memory: 32 × 32 Crossbar Array Resistive Memory Composed of a Stacked Schottky Diode and Unipolar Resistive Memory (Adv. Funct. Mater. 11/2013). Advanced Functional Materials, 2013, 23, 1350-1350.	14.9	2
33	Weight Update Generation Circuit Utilizing Phase Noise of Integrated Complementary Metal–Oxide–Semiconductor Ring Oscillator for Memristor Crossbar Array Neural Networkâ€Based Stochastic Learning. Advanced Intelligent Systems, 2020, 2, 2000011.	6.1	2
34	In-Memory Hamming Error-Correcting Code in Memristor Crossbar. IEEE Transactions on Electron Devices, 2022, 69, 3700-3707.	3.0	2
35	Nextâ€Generation Memory: Doubleâ€Layerâ€Stacked One Diodeâ€One Resistive Switching Memory Crossbar Array with an Extremely High Rectification Ratio of 10 <sup>9</sup> (Adv. Electron. Mater. 7/2017). Advanced Electronic Materials, 2017, 3, .	5.1	1

36 Stateful logic circuit and material using memristors. , 2017, , .

#	Article	IF	CITATIONS
37	Cu cone inserted CBRAM device fabrication and its improved switching reliability induced by field concentration effect. , 2018, , .		0